PTO/SB/33 (07-05)
Approved for use through xx/xx/200x. OMB 0651-00xx
U.S. Patent and Trademark Office; U.S. DEPARTMENT OF COMMERCE

Under the Paperwork Reduction Act of 1995, no persons are required to resp	ond to a collection	of information unle	ss it displays a valid OMB control number
PRE-APPEAL BRIEF REQUEST FOR REVIEW		Docket Number (Optional)	
		TESSERA 3.0-337 II	
	Application N	umber	Filed
		6,825 #5077	February 25, 2004
	First Named Inventor		
	Belgacem Haba and Yoichi Kubota		
	Art Unit		Examiner
	28	391	S.J. Fulk
Applicant requests review of the final rejection in the above-identified application. No amendments are being filed with this request.  This request is being filed with a notice of appeal.			
The review is requested for the reason(s) stated on the atta Note: No more than five (5) pages may be provided  I am the applicant /inventor.		MM	
assignee of record of the entire interest.  See 37 CFR 3.71. Statement under 37 CFR 3.73(b) is enclosed. (Form PTO/SB/96)	- -		Signature tchell J. Mehlman sed or printed name
x attorney or agent of record.			
Registration number 50,916			
attorney or agent acting under 37 CFR 1.34.	_		908) 654-5000 elephone number
Registration number if acting under 37 CFR 1.34.		Fe	bruary 15, 2008
NOTE: Signatures of all the inventors or assignees of record of the entire interest or their representative(s) are required.  Submit multiple forms if more than one signature is required, see below*.			
Table 1 for a submitted			<u> </u>
*Total of form is submitted.			<u> </u>

I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being deposited with the U.S. Postal Service on the date shown below with sufficient postage as First Class Mal, in an envelope addressed to: MS AF, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Dated: February 15, 2008

oc Code: AP.PRE.REQ

Signature:

(Mitchell J. Mehlman)



The present pre-appeal brief request is being filed after the Final Office Action dated January 14, 2008.

in this application. 1-32 are pending Claims Claims 22-32 are withdrawn as being directed to a non-elected In response to Applicants' remarks filed on invention. October 31, 2007, the Examiner issued a Final Action rejecting claims 1-5, 7, 8, 10, 12-18, 20 and 21 under 35 U.S.C. § 102(e) as being anticipated by U.S. Patent No. 6,441,481 to Karpman (hereinafter "Karpman"). Claims 6 and 11 are rejected under 35 U.S.C. § 103(a) over Karpman and claims 9 and 19 rejected under U.S.C. § 103(a) over Karpman in view of U.S. Patent No. 6,309,910 to Haba et al. (hereinafter "Haba"). Applicants respectfully submit that all pending claims are allowable and that the application is in condition allowance.

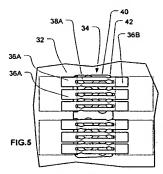
Applicants respectfully submit that the invention is not anticipated by Karpman because Karpman does teach assembling a wafer having a multiplicity of spaced-apart caps projecting upwardly therefrom, with a terminal bearing element incorporating an array of terminals. Specifically, Karpman teaches "The cap wafer 20 then is pressed to the frit glass 22 to hermetically seal the microstructures, as shown in FIG. 8." Karpman, Col. 5 11.11-12. Furthermore, Karpman teaches " . . . the cap wafer 20 is prefabricated with individual circuits 30 along its surface." Col. 5 11.17-18. Clearly, Karpman does not teach mounting the terminals simultaneously on a plurality of spaced-apart caps. Rather, in stark contrast, Karpman teaches mounting circuitry on a single continuous cap wafer.

As previously argued in Applicants' response filed October 31, 2007, claim 1 recites assembling at least a portion of a wafer having a main surface and a multiplicity of spacedapart caps projecting upwardly therefrom with a terminal bearing element incorporating an array of terminals. In such

way, the terminals are mounted simultaneously on the plurality of spaced-apart caps.

As used in claim 1, the term "spaced-apart" is given the normal meaning, such that for example, the spaced-apart caps define "depressions in the form of channels between the caps" as disclosed in the present application at paragraph [0032].

An exemplary embodiment is described at paragraph [0036] of the present application: "[b]y assembling the tape to the wafer, terminals and leads are assembled to a large number of caps 14 simultaneously. In the particular embodiment shown [in FIGS. 5 and 6], the terminals [36] are assembled to all of the caps [14] on the entire wafer [10] in a single operation." (See FIG. 5 reproduced below).



As stated above, in Karpman's method, a terminalbearing element incorporating an array of terminals is not assembled with a wafer having spaced-apart caps so as to mount the terminals simultaneously on the plurality of spaced-apart Rather, Karpman teaches a different method, that is, caps. mounting circuitry on a continuous cap wafer, and separating the cap wafer into individual capped regions. Applicants assert that Karpman teaches away from Applicants' invention:

"After the cap wafer 20 is sealed to the substrate wafer 10, the next step in the process of the invention is to separate the cap wafer so that unnecessary portions of the cap wafer are removed and access can be gained to the underlying

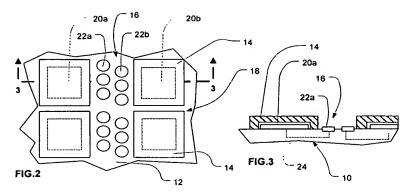
portions of the substrate wafer. FIG. 12 shows this step of the invention." Karpman, Col. 5 11.50-55. [emphasis added]. This cap wafer limitation is also evident by the process flow sequence disclosed in Karpman as depicted in figures 6-16 and as described in the associated detailed description. Karpman, Col. 5 11.1 — Col. 6 11.24.

Additionally, Karpman teaches away from the method in claim 3, wherein the terminal-bearing element recited includes leads aligned with channels between the spaced-apart caps. Quite clearly, Karpman's method would not work in the process recited in claim 3 because the wafer saw used in Karpman's method to cut the wafer would damage the leads of the previously attached terminal bearing element which are aligned with the channels between the caps.

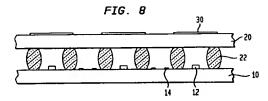
Further, applicants respectfully submit that the invention recited in claim 13 is not taught by Karpman. Similar to the discussion above, there are no depressions in the cap wafer described in Karpman at the time the terminal bearing element is assembled thereto. Again, Karpman teaches that the cap wafer is only cut after attaching circuitry thereto.

It is respectfully submitted that the Examiner's Response to Arguments in the Office Action dated January 14, 2008, relies on an apparent misconception about the subject matter recited in method claims 1 and 13.

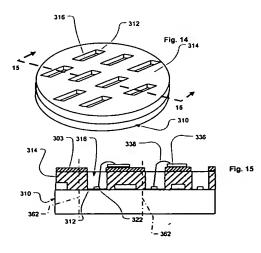
For example, step (a) of claims 1 requires assembling terminal-bearing element incorporating an terminals 22 with a multiplicity of spaced-apart caps 14, so as to mount terminals 22 simultaneously on a plurality of the spaced-apart caps 14 as shown, for example, in FIGS. 2 and 3 below.



Since Karpman's method does not mount terminals 30 simultaneously to any spaced-apart caps, and only mounts terminals 30 to a single cap wafer 20 (See FIG. 8 below), this element of claim 1 is not met by Karpman.



Furthermore, claim 13 requires assembling a wafer having depressions extending into the wafer with a terminalbearing element incorporating an array of terminals so as to mount a plurality of terminals simultaneously on the upper surface of the wafer. Karpman does not teach assembling a wafer 310 having depressions 316 or mounting a plurality of terminals 336 simultaneously on the upper surface 303 of said wafer.



Application No.: 10/786,825 Docket No.: TESSERA 3.0-337 II

Based on the foregoing, Karpman does not anticipate claim 1 or claim 13 of the present application. Accordingly, Applicants respectfully request reconsideration and withdrawal of the § 102 rejection of claims 1 and 13. Applicants also respectfully assert that claims 2-5, 7, 8, 10, and 12 are allowable, at least because they depend from claim 1, and that claims 12-18, 20 and 21 are allowable, at least because they depend from claim 13. Applicants, therefore, respectfully request that the § 102(e) rejection of claims 1-5, 7, 8, 10, 12-18, 20 and 21 be withdrawn.

With respect to the § 103(a) rejection of claims 6 and 11 over Karpman, Applicants respectfully assert that claims 6 and 11 are allowable because they depend from claim 1 which, as set forth above, is believed to be allowable. Similarly, Applicants respectfully assert that claims 9 and 19 allowable because they depend from claims 1 13, respectively, which, as set forth above, are believed to be allowable and because the addition of Haba does not overcome the deficiencies of Karpman with respect to claims 1 or 13. Accordingly, Applicants respectfully request reconsideration and withdrawal of the § 103 rejection of claims 6, 9, 11 and 19.

In view of the above, each of the presently pending claims in this application is believed to be in immediate condition for allowance.

845822\_1